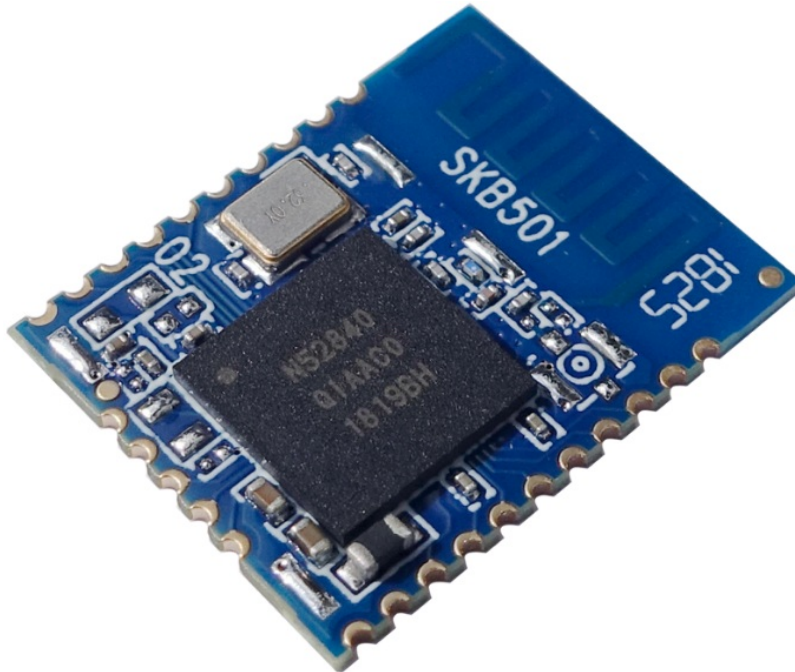




RINO XY2612-T5 Bluetooth Low Power Module User Manual

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Product Using Instruction

Version update note

Serial number	Update date	Update content	Updated version
1	2023-8-15	New document, initial version	V01
2	2024-4-15	Change four layers of boards	V02
3	2024-6-05	Change description	V03

Product overview

XY2612-T5 is designed and produced by Shenzhen Xiyun Technology Co., Ltd. based on TELINK TLSR8258F1KET32 wireless SOC. It is a small size, lowpower consumption, high reliability, low power embedded Bluetooth MESHAdhocnetworking module working in 2.4GHz band. It supports SIG MESH V1.0 standard. Asingle network theory can accommodate a maximum of 16,383 node devices. Thechip comes with a 32-bit high-performance MCU up to 48MHz, with a maximumtransmit power of 10dBm and a minimum cycle sleep current of 0.4uA

Features

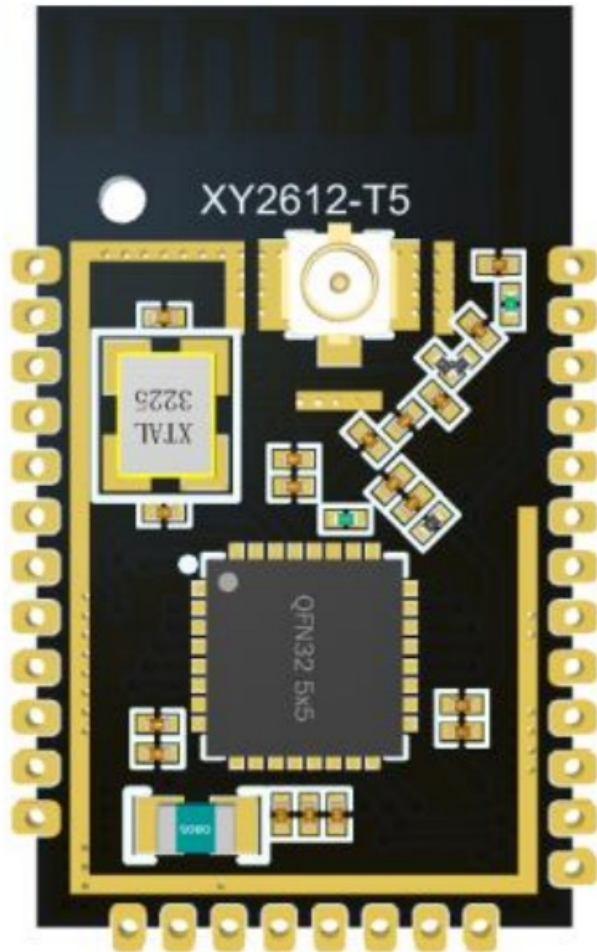
- Built-in low-power 32-bit CPU that can double as an application processor
- The main frequency supports 48 MHz
- Wide operating voltage: 1.8V-3.6V (typical supply voltage : 3.3V Peripheral: 9xPWM, 1xUART, 1xSWS
 - Bluetooth RF features
 - Bluetooth Bluetooth 5.3
 - Rf data rates up to 2Mbps
 - TX Transmit power: -0.1dBm
 - RX receiving sensitivity: -96dBm@BLE 1Mbps, -93dBm@BLE 2Mbps
- Supports hardware encryption and AES 128
- Built-in onboard PCB antenna or IPX antenna interface
- Operating temperature : -40°C to 85°C

Main application field

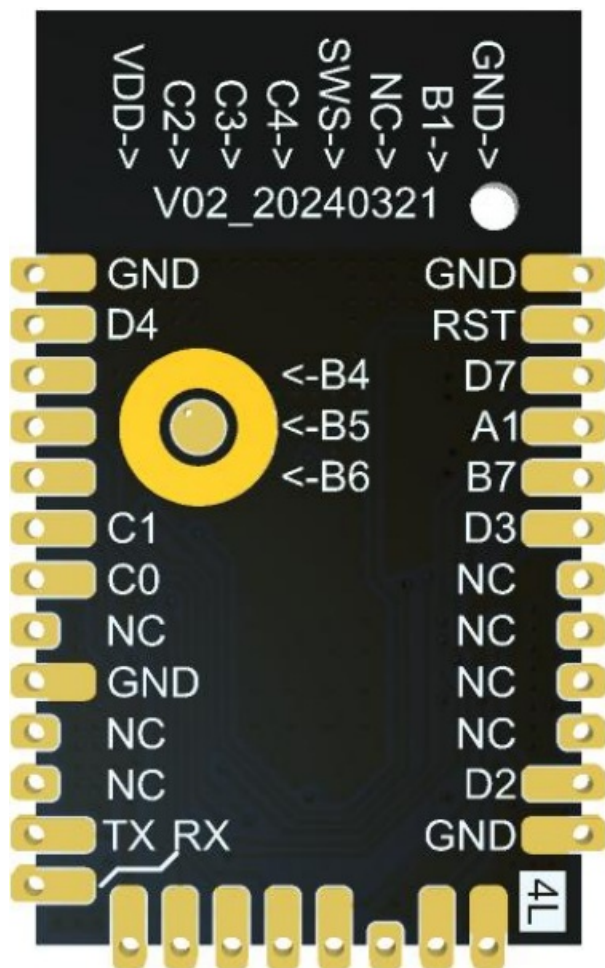
- Intelligent lighting
- Smart home
- Intelligent sensing
- Smart office
- Intelligent gateway
- Intelligent industry

1. Pin diagram

XY2612-T5 module has 3 rows of pins, a total of 33 pins, pin spacing 1.30mm.



Top view



Bottom view

The above picture is for reference only, please refer to the actual object

2. Pin definition

Interface pin definitions are shown in the following table

Pin number	symbol	IO type	Feature
1	GND	P	Module power reference
2	D4	I/O	Common I/O port, corresponding to PD4(Pin1) of the IC
3	B4	I/O	Ordinary IO port, can do LED driverPWM output, corresponding to IC PB4 (Pin14)
4	B5	I/O	Ordinary IO port, can do LED driver PWM output, corresponding to IC PB5 (Pin15)
5	B6	I/O	Ordinary IO port, can do LED driver PWM output, corresponding to IC PB6 (Pin16)
6	C1	I/O	Common I/O port, corresponding to PC1 of the IC (Pin21)

7	C0	I/O	Common I/O port, corresponding to PC0 (Pin20) of the IC
8	NC	—	Hang in the air
9	GND	P	Module power reference
10	NC	—	Hang in the air
11	NC	—	Hang in the air
12	B1	I/O	Serial port sending pin UART_TX, corresponding to PA0 (Pin6) of the IC
13	A0	I/O	Serial port receiving pin UART_RX, corresponding to IC PA0 (Pin3)
14	VDD	P	Power supply pin of the module (typical supply voltage: 3.3V)
15	C2	I/O	Ordinary IO port, can do LED driver PWM output, corresponding to IC PC2 (Pin22)
16	C3	I/O	Ordinary IO port, can do LED driver PWM output, corresponding to IC PC3 (Pin23)
17	C4	AI	Ordinary IO port, can be used as ADC
	port, 12bits ADC, corresponding to the IC PC4 (Pin24)		
18	SWS	I	Module burn pin, corresponding to IC PA7 SWS (Pin5)
19	NC	—	Hang in the air
20	B1	I/O	Serial port sending pin UART_TX, corresponding to PA0 (Pin6) of the IC
21	GND	P	Module power reference
22	GND	P	Module power reference

23	D2	I/O	Ordinary IO port, can be used as LED driver PWM output, corresponding to IC PD2 (Pin31)
24	NC	—	Hang in the air
25	NC	—	Hang in the air
26	NC	—	Hang in the air
27	NC	—	Hang in the air
28	D3	I/O	Common I/O port, corresponding to PD3 (Pin32) of the IC
29	B7	I/O	Common I/O port, corresponding to PB7 (Pin17) of the IC
30	A1	I/O	Common I/O port, corresponding to PA1 (Pin4) of the IC
31	D7	I/O	Common I/O port, corresponding to PD7 (Pin2) of the IC
32	RST	I	Hardware reset pin (active low), corresponding to IC's RESETB (Pin25)
33	GND	P	Module power reference

IP indicates the power supply pin, I/O indicates the input and output pins, AI indicates the analog input pin, and I indicates the input pin

Electrical parameters

Parameter entry	Detailed description
Operating frequency	2402~2480MHz
Wireless standard	Bluetooth 5.3
Data transfer rate	1Mbps, 2Mbps
Antenna type	Board PCB antenna or IPX antenna interface
Supply voltage	1.8-3.6V (Typical supply voltage: 3.3V)
Electrostatic release voltage (mannequin)	TAMB-25°C 2KV
Electrostatic release voltage (machine model)	TAMB-25°C 0.5KV
Operating temperature	-40°C ~ +85°C
Storage temperature	-65°C ~ +150°C

RF parameters

argument	Minimum value	Typical value	Maximum value	unit
Transmitting power				
RF average output power		-0.1		dBm
20dB modulated signal bandwidth (1M)	—	2500	—	KHz
20dB modulated signal bandwidth (2M)	—	1400	—	KHz
Receiving sensitivity				
RX sensitivity 1Mbps	—	-96		dBm
RX sensitivity 2Mbps	—	-93	—	dBm
The frequency offset error is 1 Mbps	-250	—	+300	KHz
The frequency offset error is 2 Mbps	-300	—	+200	KHz
Co-channel interference suppression	—	-10	—	dB

Power consumption in working mode

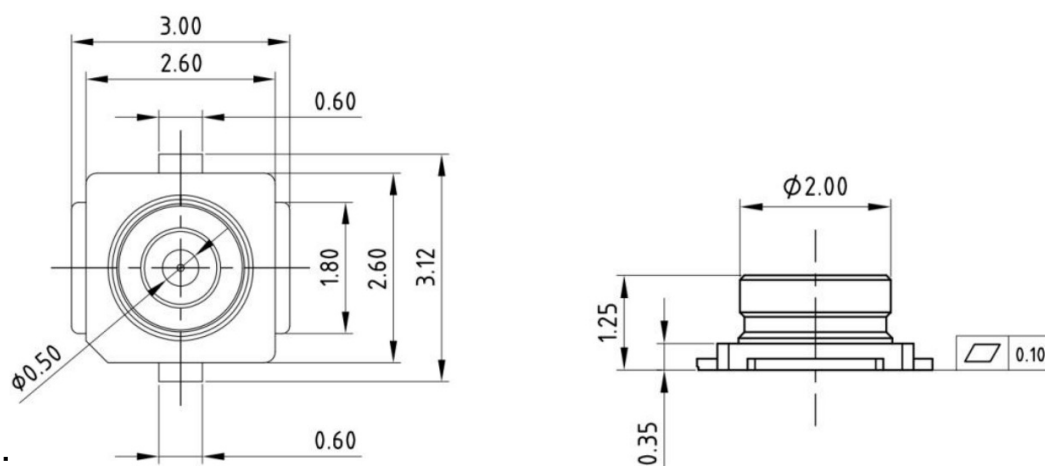
Working condition	Maximum value (typical)	unit
Continuous transmission, 10dBm output power	21	mA
Continuous reception	6.1	mA
Average value in Mesh networking state	6.7	mA
Peak value in Mesh networking state	24.9	mA
Deep Sleep mode (16KBRAM reserved)	1.2	μ A
Deep Sleep mode (no RAM reserved)	0.4	μ A

Antenna information

1. Antenna type

The XY2612-T5 module uses either an onboard PCB antenna or an IPEX antenna interface.

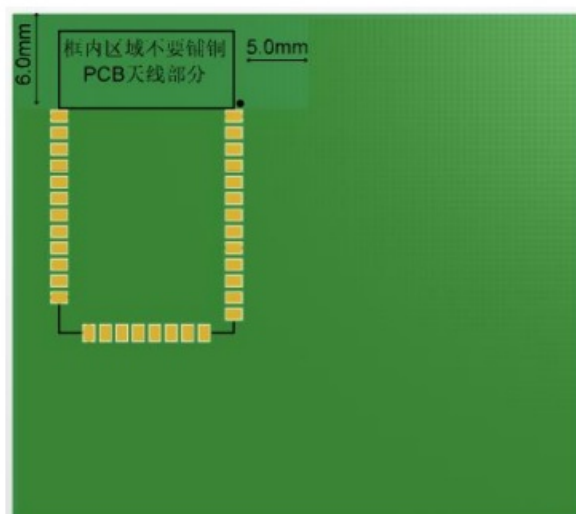
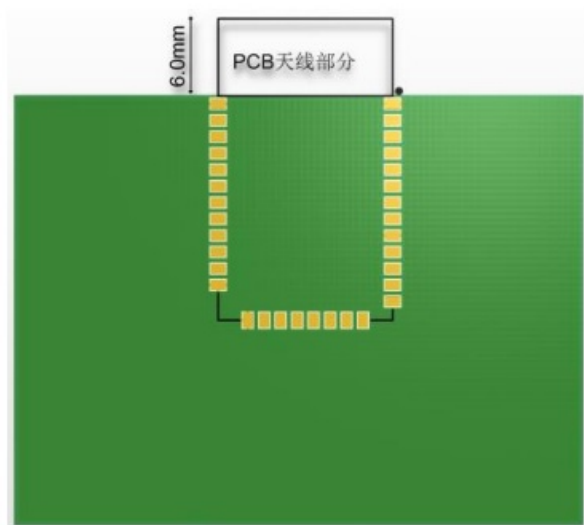
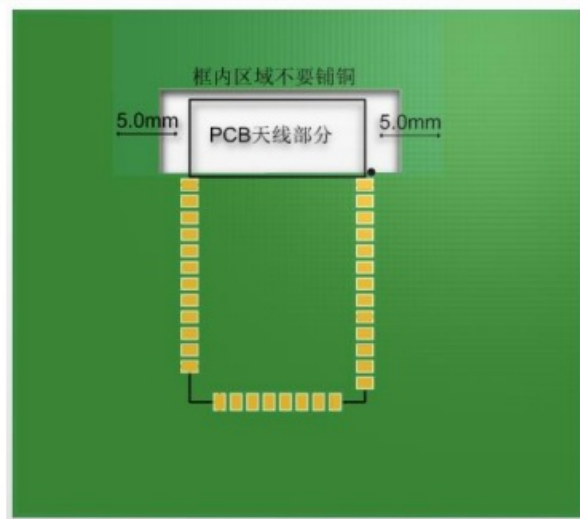
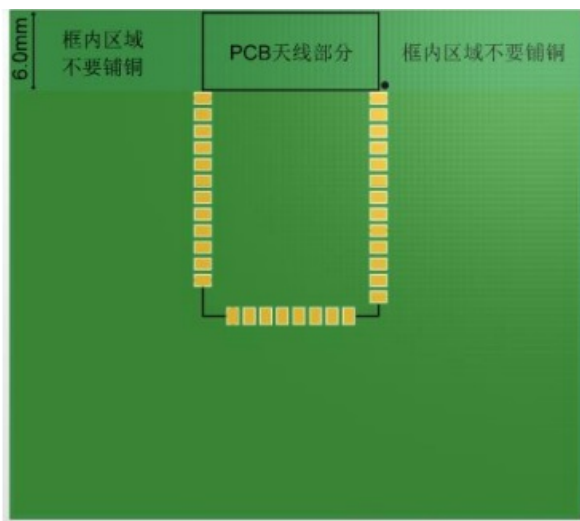
XY2612-T5 module default PCB onboard antenna. IPEX is used as a generation antenna base with the following structural



dimensions:

2. Reduce antenna interference

To ensure optimal RF performance, it is recommended that the distance between the antenna part of the module and other metal parts be at least 15mm. If metal materials are used around the antenna in the environment, the wireless signal will be greatly attenuated, and the RF performance will be deteriorated. When designing the finished product, be careful to reserve enough space for the antenna area.



Module encapsulation

XY2612-T5 module size: $13.8 \pm 0.35\text{mm}$ (W) \times $23.8 \pm 0.35\text{mm}$ (L) \times $3.0 \pm 0.15\text{mm}$ (H), PCB thickness $1.0\text{mm} \pm 0.1\text{mm}$, package as shown:

Top view:

Product model	antenna	MOQ PCS	Shipping package way	Per reel Number of packagingmodules	Each case packing Number of reels
XY2612-T5	Onboard antenna	3600	Carrying reel	900	4
XY2612-T5-IPEX	External antenna	3600	Carrying reel	900	4

List of applicable FCC rules FCC Part 15 Subpart C 15.247&15.209

Specific operational use conditions.

The module can be used for mobile applications with a maximum 0.13dBi antenna. The manufacturer installing this module into their product must ensure that the final product complies with the FCC requirements by a technical assessment or evaluation to the FCC rules, including the transmitter operation. The host manufacturer has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user's manual of the end product which integrates this module. The end user manual shall include all required regulatory information / warning as shown in this manual.

Limited module procedures. Not applicable.

The module is a Single module and complies with the requirement of FCC part 15.212.

Trace antenna designs. Not applicable.

The module as its own antenna, and doesn't need a host printed board microstrip trace antenna etc RF exposure considerations.

The module must be installed in the host equipment such that at least 20cm is maintained between the antenna and user's body, and if RF exposure statement or module layout is changed, then the host product manufacturer is required to take responsibility of the module through a change in FCC ID or new application.

The FCC ID of the module cannot be used on the final product. In these circumstances, the host manufacturer will be responsible for evaluating the end product (including the transmitter) and obtaining a separate FCC

authorization.

Antennas : Antenna Specification are as follows :

Type : PCB Antenna

Gain : 3.5dBi Max

This device is intended only for host manufacturers under the following conditions: The module shall be only used with the PCB antennas that have been originally tested and certified with this module. The antenna must be either permanently attached or employ a unique antenna coupler. As long as the conditions above are met, further transmitter test will not be required. However, the host manufacturer is still responsible for testing their end-product for any additional compliance requirements required with this module installed for example, digital device emissions, PC peripheral requirements, etc.)

Label and compliance information Host product manufacturers need to provide a physical or e-label stating "Contains FCC ID: 2A9TO-XY2612-T5 with their finished product."

Information on the modes and additional testing requirements Host manufacturers of all digital and spurious emission in all test modes for a stand-alone modular transmitter in host, as well as for multi-channel modules or other transmitters in a host product.

Only when all the test results of test modes comply with FCC requirements, then the end product can be sold legally.

Additional testing, Part 15 subpart B disclaimer. The modular transmitter is only FCC authorized for FCC Part 15

Subpart C 15.247 & 15. 209 and that the host product manufacturer is responsible for compliance to any other FCC rules that apply to the host not covered by the modular transmitter grant of certification.
If the grantee markets their product as being art 15 Subpart B compliant when it also contains unintentional radiator digital circuitry , then the grantee shall provide a notice stating that the final host product still requires art 15 Subpart B compliance testing

CAUTION: Any changes or modifications not expressly approved could void the user’s authority to operate the equipment.


This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator & your body . This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. Any changes or modifications not expressly approved by the party responsible for compliance could void the user’s authority to operate the equipment. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and(2) this device must accept any interference received , including interference that may cause undesired operation.

Note: This equipment has been tested and found to comply with the limits for a digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy, and if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.



Documents / Resources

	<p>RINO XY2612-T5 Bluetooth Low Power Module [pdf] User Manual XY2612-T5 Bluetooth Low Power Module, XY2612-T5, Bluetooth Low Power Module, Low Pow er Module, Power Module, Module</p>
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References

- [User Manual](#)

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